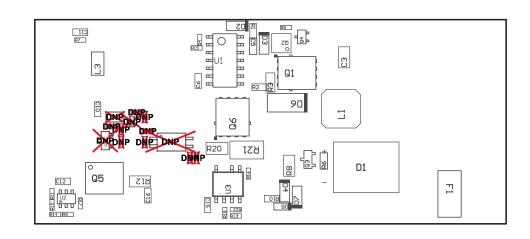


## COMPONENTS MARKED 'DNP' SHOULD NOT BE POPULATED. ASSEMBLY VARIANT: 001

PCB VIEWED FROM TOP SIDE	BOARD #: PMP11368	REV: A	SUN REV:	Not In VersionControl		
	TID #:					
PLOT NAME = Top Assembly Drawing	GENERATED : 10/14/	2015 3: 56: 36	PM	TEXAS INSTRUMENTS		



## COMPONENTS MARKED 'DNP' SHOULD NOT BE POPULATED. ASSEMBLY VARIANT: 001

PCB VIEWED FROM BOTTOM SIDE	BOARD #: PMP11368	REV: A	SUN REU:	: Not In VersionControl		
	TID #:					
PLOT NAME = Bottom Assembly Drawing	GENERATED : 10/14/	2015 3: 56: 37	PM	TEXAS INSTRUMENTS		

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